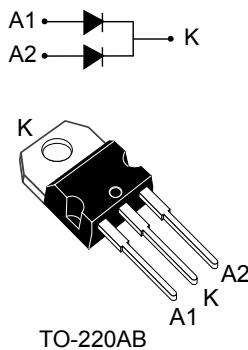


150 V power Schottky rectifier



Features

- High junction temperature capability
- Good trade-off between leakage current and forward voltage drop
- Low leakage current
- Avalanche capability rated
- ECOPACK®2 compliant

Applications

- Switching diode
- SMPS
- DC/DC converter
- LED lighting

Description

The **STPS16150C** is a dual center tap Schottky rectifier suited for high frequency switch mode power supply.

Available in TO-220AB, this device is optimized for use in LCD screens or adaptors providing such applications with good efficiency at both low and high load.

Product status link	
STPS16150C	
Product summary	
I_{F(AV)}	2 x 8 A
V_{RRM}	150 V
T_j	175 °C
V_F (typ.)	0.70 V

1 Characteristics

Table 1. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage	150	V	
$I_{F(RMS)}$	Forward rms current	20	A	
$I_{F(AV)}$	Average forward current, $\delta = 0.5$, square wave	$T_c = 150 \text{ }^\circ\text{C}$	Per diode	
			Per device	
I_{FSM}	Surge non repetitive forward current	$t_p = 10 \text{ ms sinusoidal}$	150	A
P_{ARM}	Repetitive peak avalanche power	$t_p = 10 \mu\text{s}, T_j = 125 \text{ }^\circ\text{C}$	338	W
T_{stg}	Storage temperature range		-65 to +175	$^\circ\text{C}$
T_j	Maximum operating junction temperature ⁽¹⁾	175	$^\circ\text{C}$	

1. $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameters

Symbol	Parameter	Max. value	Unit
$R_{th(j-c)}$	Junction to case	3	$^\circ\text{C/W}$
		1.8	
$R_{th(c)}$	Coupling	0.6	$^\circ\text{C/W}$

When the diodes 1 and 2 are used simultaneously: $\Delta T_j \text{ (diode1)} = P_{\text{diode1}} \times R_{th(j-c)} \text{ (per diode)} + P_{\text{diode2}} \times R_{th(c)}$

For more information, please refer to the following application note :

- AN5088 : Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
I_R ⁽¹⁾	Reverse leakage current	$T_j = 25 \text{ }^\circ\text{C}$	$V_R = V_{RRM}$	-		3.0	μA
		$T_j = 125 \text{ }^\circ\text{C}$		-		4.0	mA
V_F ⁽²⁾	Forward voltage drop	$T_j = 25 \text{ }^\circ\text{C}$	$I_F = 8 \text{ A}$	-		0.92	V
		$T_j = 125 \text{ }^\circ\text{C}$		-	0.70	0.75	
		$T_j = 25 \text{ }^\circ\text{C}$	$I_F = 16 \text{ A}$	-		1	
		$T_j = 125 \text{ }^\circ\text{C}$		-	0.80	0.86	

1. Pulse test: $t_p = 5 \text{ ms}, \delta < 2\%$

2. Pulse test: $t_p = 380 \mu\text{s}, \delta < 2\%$

To evaluate the conduction losses, use the following equation:

$$P = 0.64 \times I_{F(AV)} + 0.014 \times I_F^2 \text{ (RMS)}$$

For more information, please refer to the following application notes related to the power losses :

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

1.1 Characteristics (curves)

Figure 1. Average forward power dissipation versus average forward current (per diode)

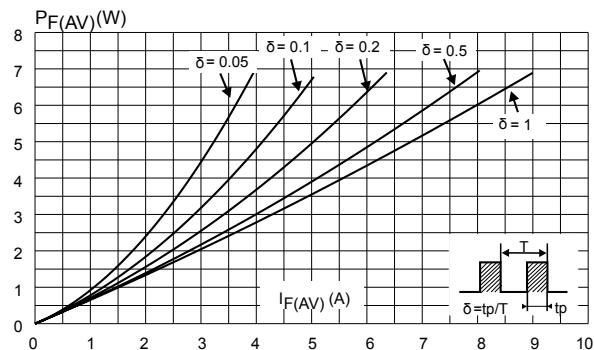


Figure 2. Average forward current versus ambient temperature ($\delta = 0.5$, per diode)

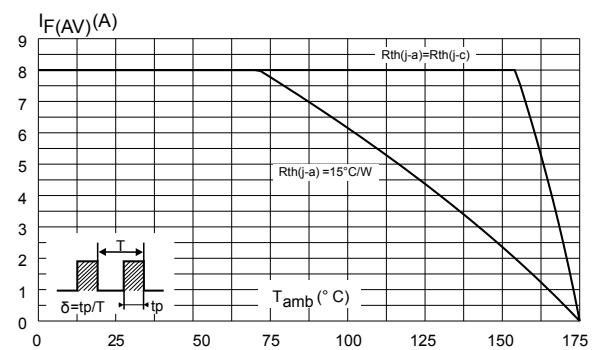


Figure 3. Normalized avalanche power derating versus pulse duration ($T_j = 125^\circ\text{C}$)

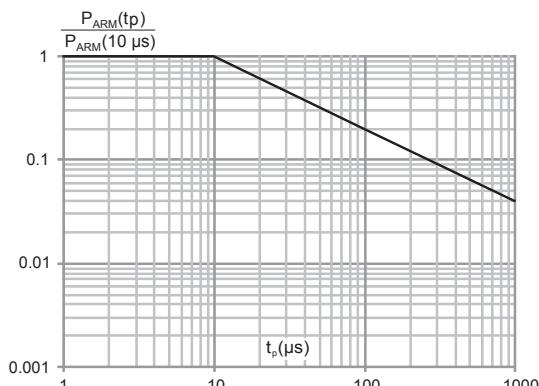


Figure 4. Relative variation of thermal impedance junction to case versus pulse duration

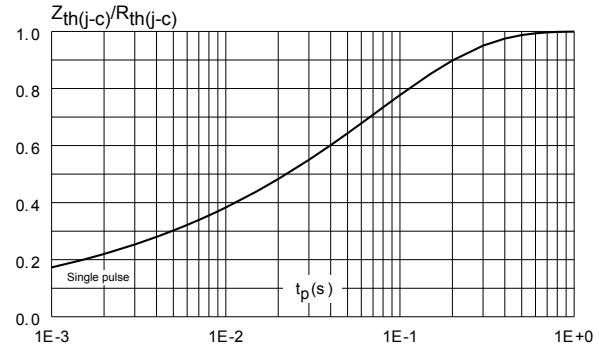


Figure 5. Reverse leakage current versus reverse voltage applied (typical values, per diode)

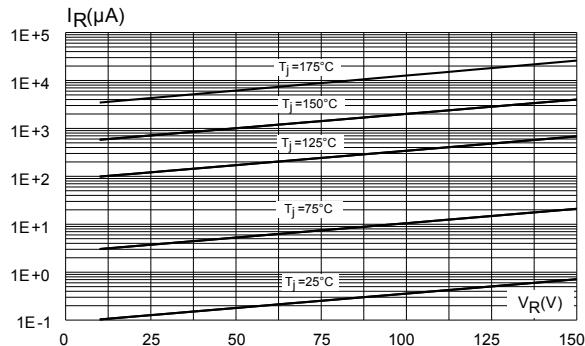


Figure 6. Junction capacitance versus reverse voltage applied (typical values, per diode)

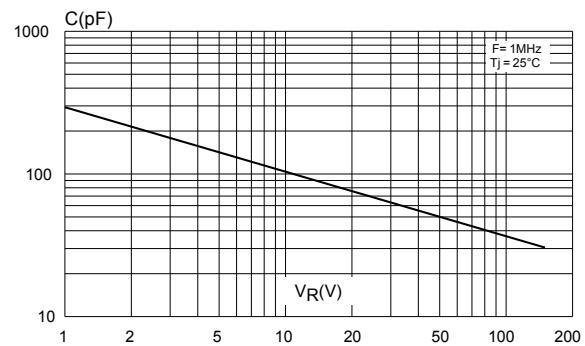
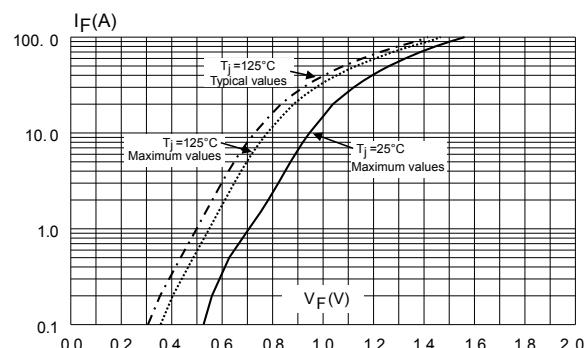


Figure 7. Forward voltage drop versus forward current (per diode)



2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

2.1 TO220AB package information

- Epoxy meets UL 94,VO
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 N·m
- Maximum torque value: 0.70 N·m

Figure 8. TO-220AB package outline

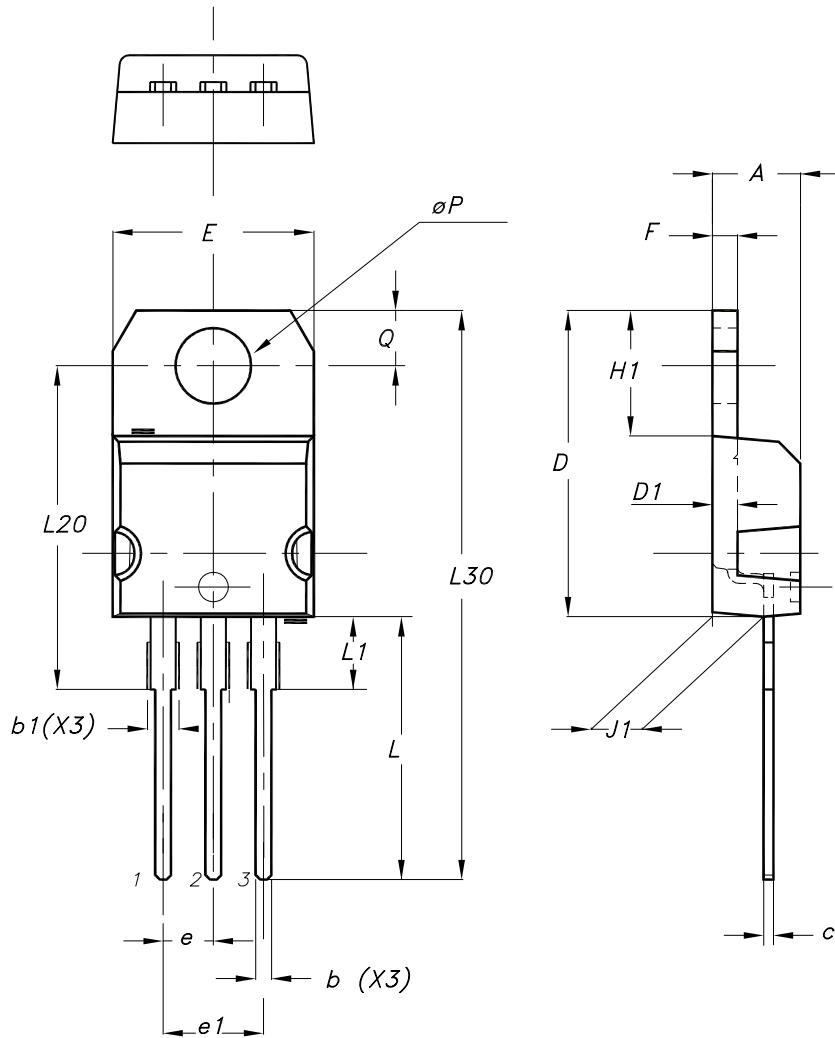


Table 4. TO-220AB package mechanical data

Ref.	Dimensions			
	Millimeters		Inches (for reference only)	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
b	0.61	0.88	0.240	0.035
b1	1.14	1.55	0.045	0.061
c	0.48	0.70	0.019	0.028
D	15.25	15.75	0.600	0.620
D1	1.27 typ.		0.050 typ.	
E	10.00	10.40	0.394	0.409
e	2.40	2.70	0.094	0.106
e1	4.95	5.15	0.195	0.203
F	1.23	1.32	0.048	0.052
H1	6.20	6.60	0.244	0.260
J1	2.40	2.72	0.094	0.107
L	13.00	14.00	0.512	0.551
L1	3.50	3.93	0.138	0.155
L20	16.40 typ.		0.646 typ.	
L30	28.90 typ.		1.138 typ.	
θP	3.75	3.85	0.148	0.152
Q	2.65	2.95	0.104	0.116

3 Ordering information

Table 5. Order code

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS16150CT	STPS16150CT	TO-220AB	1.95 g	50	Tube

Revision history

Table 6. Document revision history

Date	Revision	Changes
July-2003	2	First issue.
17-Aug-2018	3	Removed I ² PAK and D ² PAK packages. Removed figure 4, figure 5 and figure 10. Updated Section 1.1 Characteristics (curves) . Updated cover page and Table 1 . Minor text changes to improve readability.

IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2018 STMicroelectronics – All rights reserved